

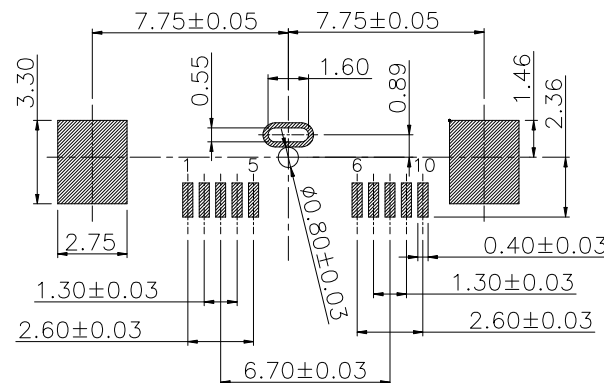
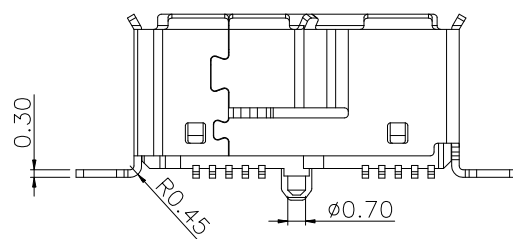
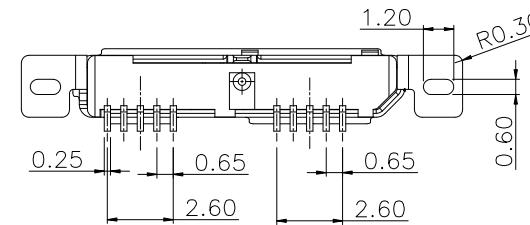
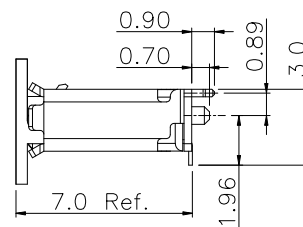
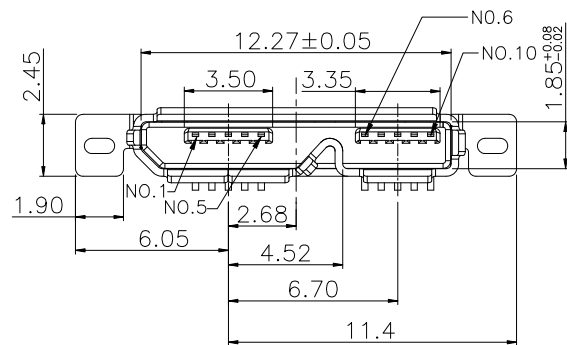
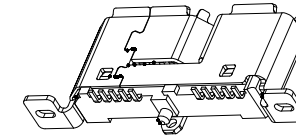
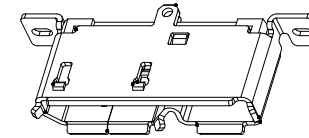
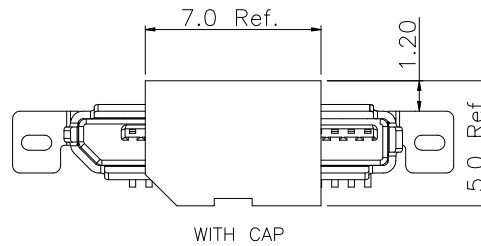
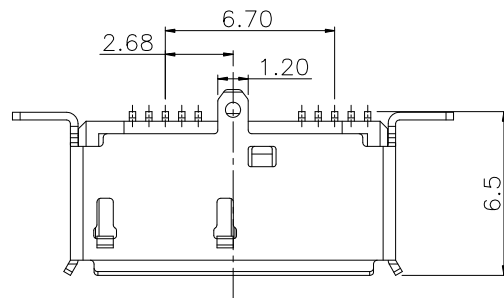
A

B

C

D

E



RECOMMENDED P.C.B LAYOUT

SPECIFICATION

MATERIAL

SHELL : STAINLESS STEEL ,0.3mm THICKNESS,
GOLD FLASH PLATED ON THE SOLDERING TAB.

HOUSING : INSULATOR: LCP . COLOR-BLACK (UL 94-V0)

CONTACT : BRASS.0.15mm THICKNESS,SELECTIVE
GOLD.PLATED ON CONTACT AREA,
GOLD FLASH PLATED ON SOLDER TAIL,

CURRENT RATING: 1 AMP MAX

DIELECTRIC WITHSTANDING: 100V AC FOR ONE MINUTE

CONTACT RESISTANCE: 30m OHMS MAX

INSULATION RESISTANCE: 100M OHMS MIN AT DC 500V

OPERATION TEMPERATURE: -25°C ~+105°C



承洧科技股份有限公司
Chong Wei Technology Corp.

DESCRIPTION(內容):

MICRO USB 3.0 B TYPE,
VERTICAL SMT,FEMALE(RoHS)

PART NO:
(料 號) UMMBF-101VBCB-CF1066

DWG NO(圖號): 22WCH-104T-123L

DRAWN(製圖):

GONG

CHECKED(確認):

TERESA

APPROVAL(核准):

JOHNNY

GENERAL TOLERANCE:
(公差)

. X ±0.30
. XX ±0.20

SCALE(比例):

FREE



REV:

R1

UNIT:

mm

SIZE:

A4

SHEET:

1/2

REV

R0

R1

R2

R3

DESCRIPTION

RELEASE
圖面更新、變更料號(原:UMMBF-101MBCB1-CF1066)

DATE

2015.10.21

2018.10.30

A

B

C

D

E